

CUSTOMER 客户:

规格书编号

SPEC NO:

产品规格书 SPECIFICATION

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PRODUCT 产品:_	SAW FILTER								
MODEL NO 型 号:_	HDF447.725M SMD-3								
MARKING 印字:_	HDF452								
PREPARED 编 制:_	CHECKED 审 核	亥:							
APPROVED 批准:_	APPROVED 批 准: D A T E 日 期: 2006-5-11								
客户确认 CUSTOMER RECEIVED:									
审核 CHECKED 批准 APPROVED 日期 DATE									

无锡市好达电子有限公司 Shoulder Electronics Limited



更改历史记录 History Record

更改日期 Date	规格书编号 Spec. No.	产品型号 Part No.	客户产品型号 Customer No.	更改内容描述 Modify Content	备注 Remark

SAW FILTER

1.SCOPE

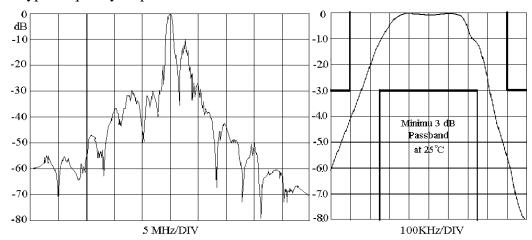
This specification shall cover the characteristics of SAW filter with 447.725MHz used for remote-control security.

2. ELECTRICAL SPECIFICATION

DC Voltage VDC	10V
AC Voltage Vpp	10V50Hz/60Hz
Storage temperature	-45°C to +85°C
RF Power Dissipation	0dBm

Electronic Characteristics

2-1. Type frequency response



2-2. Electrical characteristics

C	hara	cteristics	Sym	Notes	Min.	Typical	Max.	Units
Center	A	bsolute Frequency	Fc	1.2	446.650	447.725	447.800	M Hz
Frequency	to	olerance from Nominal	Δ fc				±75	KHz
Insertion I	oss		IL	1		1.7	3.0	dB
3dB Band	widt	h	BW3	1.2	500	700	800	KHz
Rejection	At	fo-21.4MHz (Image)		1	40	50		dB
	At fo-10.7 MHz (LO) Ultimate				16	40		
						80		
Temperatu	re	Operating case temp.	Tc	3.4	-35		+85	$^{\circ}$
characteris	stics	Tumover temp.	То		22	37	62	$^{\circ}$
Tumover Frequency Freq.temp.coefficient		Tumover Frequency	fo			fc		MHz
		FTC			0.032		ppm/℃	
Frequency aging				5		<±10		ppm/y

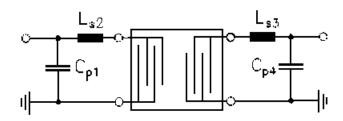


Note:

- 1. Typical test circuit is shown as below.
- 2. Passband and reject bands are specified in reference to fc.
- 3. The turnover temperature, To, is the temperature at the maximum frequency, Fo.
- 4. The nominal frequency at any case temperature, Tc, inside the operating temperature range may be calculated from:f=fo[1-FTC(To-Tc)²].

Typical aging is for 10 years.

3. TEST CIRCUIT

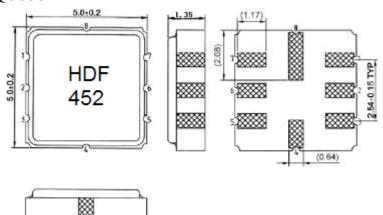


Cp1 =10pF, Ls2 =43nH*, Ls3 =43nH*, Cp4 =10pF

Ls2 = Ls3 = 6 turns of 0.51mm insulated Copper, 2.5mm ID.

4. DIMENSION

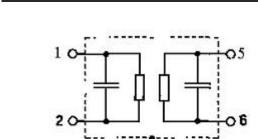
Ceramic package QCC8C



Dimensions in mm, appr. weight 0.1

Marking: HDF452

HD: Brand F: Filter 452: No.



Pin Configuration	
2	Input
6	Output
1, 3, 4, 5, 7, 8	Case ground

5. ENVIRONMENTAL CHARACTERISTICS

5-1 Temperature cycling

Subject the device to a low temperature of -40° C for 30 minutes. Following by a high temperature of $+25^{\circ}$ C for 5 Minutes and a higher temperature of $+85^{\circ}$ C for 30 Minutes. Then release the device into the room conditions for 1 to 2 hours prior to the measurement. It shall meet the specifications in 2-2.

5-2 Resistance to solder heat

Submerge the device terminals into the solder bath at 260° C $\pm 5^{\circ}$ C for 10 ± 1 sec. Then release the device into the room conditions for 4 hours. It shall meet the specifications in 2-2.

5-3 Solderability

Submerge the device terminals into the solder bath at 245° C $\pm 5^{\circ}$ C for 5s, More than 95% area of the soldering pad must be covered with new solder. It shall meet the specifications in 2-2.

5-4 Mechanical shock

Drop the device randomly onto the concrete floor from the height of 1 m 3 times. The filter shall fulfill the specifications in 2-2.

5-5 Vibration

Subject the device to the vibration for 2 hour each in x,y and z axes with the amplitude of 1.5 mm at 10 to 55 hz. The filter shall fulfill the specifications in 2-2.

6. REMARK

6.1 Static voltage

Static voltage between signal load & ground may cause deterioration &destruction of the component. Please avoid static voltage.

6.2 Ultrasonic cleaning

Ultrasonic vibration may cause deterioration & destruction of the component. Please avoid ultrasonic cleaning

6.3 Soldering

Only leads of component may be soldered. Please avoid soldering another part of component.



7. Packing

7.1 Dimensions

(1) Carrier Tape: Figure 1

(2) Reel: Figure 2

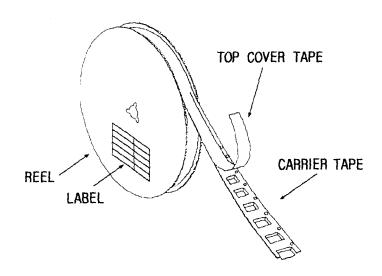
(3) The product shall be packed properly not to be damaged during transportation and storage.

7.2 Reeling Quantity

1000 pcs/reel 7" 3000 pcs/reel 13"

7.3 Taping Structure

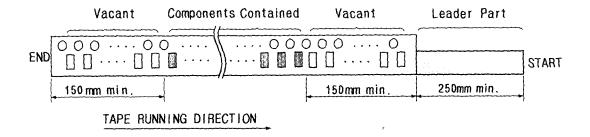
(1) The tape shall be wound around the reel in the direction shown below.



(2) Label

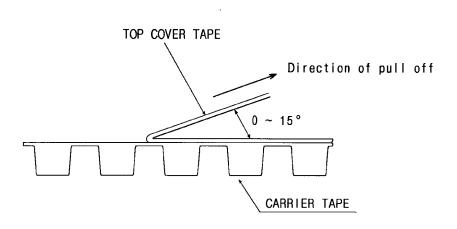
Device Name	
User Product Name	
Quantity	
Lot No.	

(3) Leader part and vacant position specifications.

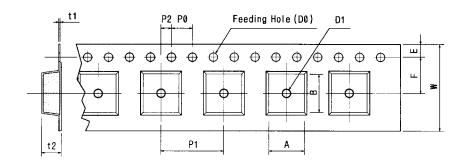


8. TAPE SPECIFICATIONS

- 8.1 Tensile Strength of Carrier Tape: 4.4N/mm width
- 8.2 Top Cover Tape Adhesion (See the below figure)
 - (1) pull off angle: 0~15°
 (2) speed: 300mm/min.
 (3) force: 20~70g



[Figure 1] Carrier Tape Dimensions



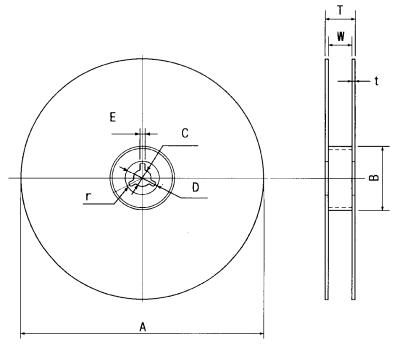
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[Unit:mm]

W	F	Е	P0	P1	P2	D0	D1	t1	t2	A	В
12.0	5.5	1.75	4.0	8.0	2.0	Ø1.5	Ø1.0	0.3	2.10	6.40	5.20
± 0.3	± 0.05	± 0.1	± 0.1	± 0.1	± 0.05	± 0.1	± 0.25	± 0.05	± 0.1	± 0.1	± 0.1

[Figure 2]

[Unit:mm]



A	В	С	D	Е	W	t	r
Ø330	Ø100	Ø13	Ø21	2	13	3	1.0
± 1.0	± 0.5	± 0.5	± 0.8	± 0.5	± 0.3	max.	max.